

DATA SHEET

SE2438T: 2.4 GHz ZigBee®/Smart Energy Front-End Module

Applications

- · Smart meters
- · In-home appliances
- · Smart thermostats

Features

- · Integrated:
 - PA with up to +16 dBm output power
 - LNA with programmable bypass
 - Transmit and receive switching function
- +2.7 dB FEM Rx NF
- · Differential Rx/Tx interface with integrated balun
- Fast switch on/off time <800 ns
- 2.0 V to 3.6 V supply operation
- Sleep mode current 0.05 µA typical
- QFN (20-pin, 3.0 mm x 3.0 mm x 0.55 mm) package (MSL1 @ 260 °C per JEDEC J-STD-020)



Skyworks GreenTM products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green*TM, document number SQ04-0074.

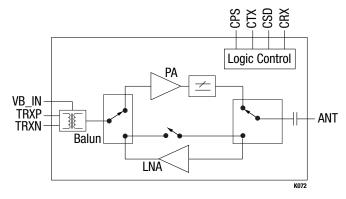


Figure 1. SE2438T Block Diagram

Description

The SE2438T is a high-performance, fully integrated RF Front-End Module (FEM) that is designed for ZigBee®/Smart Energy applications.

The SE2438T is designed for ease of use and maximum flexibility, with integrated fully matched input balun, integrated inter-stage matching and harmonic filter, and digital controls that are compatible with 1.6 V to 3.6 V Complementary Metal Oxide Semiconductor (CMOS) levels.

The RF blocks operate over a wide supply voltage range from 2.0 V to 3.6V, which allows the SE2438T to be used in battery-powered applications over a wide spectrum of the battery discharge curve.

A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

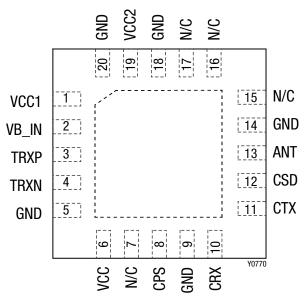


Figure 2. SE2438T Pinout—20-Pin QFN (Top View)

Table 1. SE2438T Signal Descriptions

Pin	Name	Description	Pin	Name	Description
1	VCC1	Positive supply	12	CSD	Sleep mode control
2	VB_IN	Bias voltage input supply to the transceiver	13	ANT	Connect to 50 Ω antenna
3	TRXP	Input/output signal to the transceiver, 100 $\ensuremath{\Omega}$ differential	14	GND	Connect to PCB ground
4	TRXN	Input/output signal to the transceiver, 100 $\ensuremath{\Omega}$ differential	15	N/C	Not connected
5	GND	Connect to PCB ground	16	N/C	Not connected
6	VCC	Positive supply	17	N/C	Not connected
7	N/C	Not connected	18	GND	Connect to PCB ground
8	CPS	Bypass mode control, connect to RFIC or SoC GPIO	19	VCC2	Positive supply
9	GND	Connect to PCB the ground	20	GND	Connect to PCB ground
10	CRX	Receive function control	Paddle	GND	Exposed die paddle; electrical and thermal ground; connect to
11	CTX	Transmit function control	rauule	GIND	PCB ground

Electrical and Mechanical Specifications

The absolute maximum ratings of the SE2438T are provided in Table 2. The recommended operating conditions are specified in Table 3, and electrical specifications are provided in Tables 4 through 7.

The state of the SE2438T is determined by the logic provided in Table 8.

Table 2. SE2438T Absolute Maximum Ratings

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage	Vcc1, Vcc2, Vcc3	-0.3	3.6	V
Control pin voltages		-0.3	3.6	V
Operating temperature	Та	-40	125	°C
Storage temperature	Тѕтс	-40	125	°C
Tx output power at the ANT port into 50 Ω load	POUT_TX_MAX		+16	dBm
Tx input power at the TR port	PIN_TX_MAX		+6	dBm
Rx input power at the ANT port	PIN_RX_MAX		+5	dBm
Thermal resistance	θις		69	°C/W
Electrostatic discharge:	ESD			
Human Body Model (HBM), Class 1C			1000	V

Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

CAUTION: Although this device is designed to be as robust as possible, Electrostatic Discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

Table 3. Recommended Operating Conditions

Parameter	Symbol	Minimum	Typical	Maximum	Units
Ambient temperature	Та	-40	+25	+125	°C
Supply voltage for transceiver core	V _{B_IN}	1.6		3.6	V
Supply voltage on Vcc pins	Vcc1, Vcc2, Vcc3	2.0	3.0	3.6	V

Table 4. SE2438T Electrical Specifications: DC (Note 1) (VCC = VCC1 = VCC2 = 3 V, TA = +25 °C, Measured on the Evaluation Board [De-embedded to the Device], Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Total supply current	lcc_ Tx14	Tx mode Pout = +14 dBm		33		mA
Total supply current	lcc_ Tx12	Tx mode Pout = +12 dBm		25		mA
Total supply current	lcc_ Tx10	Tx mode Pout = +10 dBm		20		mA
Quiescent current	Icq_ Tx	No RF		6		mA
Total supply current	Icc_ Rxhg	Rx Low Noise Amplifier (LNA) High Gain mode		5.5		mA
Total supply current	Icc_ Rxlg	Rx LNA Low Gain mode		2.7		mA
Total supply current	Icc_ RxBypass	Rx Bypass mode			10	μА
Sleep supply current	ICC_ OFF	No RF		0.05	1.0	μΑ

Note 1: Performance is guaranteed only under the conditions listed in this table.

Table 5. SE2438T Electrical Specifications: Logic Characteristics (Note 1) (VB_IN = 1.6 to 3.6 V, VCC = VCC1 = VCC2 = 3.0 V, TA = +25 °C, Measured on the Evaluation Board [De-embedded to the Device], Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Logic input high voltage	VВінв		1.6		3.6	V
Logic input low voltage	VBILB		0		0.3	٧
Logic input high current	IВ _{ІНВ}				1	μА
Logic input low current	IBILB				1	μА

Note 1: Performance is guaranteed only under the conditions listed in this table.

Table 6. SE2438T Electrical Specifications: AC Characteristics (Note 1) (VB_IN = 1.6 V to 3.6 V, VCC = VCC1 = VCC2 = 3.0 V, TA = +25 °C, Measured on the Evaluation Board [De-embedded to the Device], All Unused Ports Terminated with 50 Ω , Unless Otherwise Noted)

Parameter	Parameter Symbol Test Condition			Typical	Maximum	Units
Transmit (Tx)				•		
Frequency range	fin		2400		2483	MHz
Output power at ANT port	Роит_ні	2400 MHz to 2483 MHz, 0EVM = 1% typical: VCC = VCC1 = VCC2 = 3.6 V VCC = VCC1 = VCC2 = 3.3 V VCC = VCC1 = VCC2 = 3.0 V VCC = VCC1 = VCC2 = 2.0 V VCC = VCC1 = VCC2 = 1.8 V		+16.0 +15.0 +14.0 +11.0 +9.5		dBm
Small signal gain high power mode	S21_ні	2400 MHz to 2483 MHz	14			dB
Small signal gain variation	Δ\$21	2400 MHz to 2483 MHz Gain variation across all 802.15.4 channels			1	dBp-p
Second and third harmonics	HD2, HD3	2400 MHz to 2483 MHz IEEE 802.15.4 source Pouτ = +14 dBm Measured with the antenna match and filter components per the SE2438T-EK1 evaluation board			-42	dBm/ MHz
Spectral mask	ACP	2400 MHz to 2483 MHz Integrated power from the band edges to fc ± 3.5 MHz			-30	dBm
Turn on and off times	ton	From 50% of the CTX edge to 90% of the final RF output power. From 50% of the CTX edge to 10% of the final RF output power.			800	ns
Stability STA		CW, PIN = +0 dBm 0.1 GHz to 20.0 GHz Load VSWR = 6:1	All non-harmonically related outputs <-35.0 dBm/MHz			
Ruggedness	Ru	CW, PIN = +6 dBm, Load VSWR = 10:1	No permanent damage			
Receive (Rx)						
Frequency range	fin		2400		2483	MHz
Rx gain high gain mode	Rx_gain_HG	2400 MHz to 2483 MHz	10.3	12.3	14.3	dB
Rx gain low gain mode	Rx_gain_LG	2400 MHz to 2483 MHz	5	7	9	dB
Rx Noise Figure (NF) high gain mode	NF_HG	2400 MHz to 2483 MHz		2.7		dB
Rx NF low gain mode	NF_LG	2400 MHz to 2483 MHz		+3.8		dB
Input 1-dB compression point high gain mode	IP1dB_HG	2400 MHz to 2483 MHz	-13	-8		dBm
Input 1-dB compression point low gain mode	IP1dB_LG	2400 MHz to 2483 MHz	-3	+2		dBm
Turn on and off times topp		From 50% of the CTX edge to 90% of the final RF output power. From 50% of the CTX edge to 10% of the final RF output power.	80		800	ns
Gain in bypass mode	G_bp			-3.5		dB
Input 1-dB compression point in bypass mode	IP1dB		+10			dBm

Note 1: Performance is guaranteed only under the conditions listed in this table.

Table 7. SE2431L Electrical Specifications: AC Characteristics, Antenna Switch (Note 1) (Vcc1 = Vcc2 = Vcc2 = 3 V, TA = +25 °C, Measured on the Evaluation Board [De-embedded to the Device], All Unused Ports Terminated with 50 Ω , Unless Otherwise Noted)

Parameter	Symbol	Min	Typical	Max	Units
Input return loss at ANT port, Rx mode	S11		-10	- 5	dB
Output return loss at ANT port, Tx mode	S22		-10	- 5	dB

Note 1: Performance is guaranteed only under the conditions listed in this table.

Table 8. SE2438T Logic Controls (Note 1) (VB_IN = 1.6 V to 3.6 V, VCC = VCC1 = VCC2 = 3.0 V, TA = +25 °C, Unless Otherwise Noted)

Mode	Description	CSD	CPS	CRX	СТХ	Current Consumption
0	All off	0	0	0	0	Table 4
1	Standby	0	0	0	1	1.907 μΑ
2	Standby	0	0	1	0	1.907 μΑ
3	Standby	0	0	1	1	3.8 μΑ
4	Standby	0	1	0	0	1.907 μΑ
5	Standby	0	1	0	1	3.8 μΑ
6	Standby	0	1	1	0	3.8 μΑ
7	Standby	0	1	1	1	5.69 μA
8	Standby	1	0	0	0	1.907 μΑ
9	Tx bypass mode	1	0	0	1	Same as Rx Bypass mode (Table 4)
10	Rx bypass mode	1	0	1	0	Table 4
11	Regulator enabled	1	0	1	1	210 μΑ
12	Rx LNA (LG)	1	1	0	0	Table 4
13	TX high power mode	1	1	0	1	Table 4
14	Rx LNA(HG)	1	1	1	0	Table 4
15	Standby	1	1	1	1	7.6 μA

Note 1: Performance is guaranteed only under the conditions listed in this table.

Evaluation Board Description

The SE2438T Evaluation Board is used to test the performance of the SE2438T FEM. The board is optimized for evaluation, experimentation, and investigation with an 802.15.4 signal source. The design and layout can be quickly and easily transferred into a production design.

An Evaluation Board schematic diagram is provided in Figure 3. A reference design schematic is provided in Figure 4. Table 9 describes the pins on the power and control I/O header (J3). Table 10 provides the Bill of Materials (BOM) list for Evaluation Board components. A photograph of the Evaluation Board is shown in Figure 5.

Evaluation Board Setup Procedure

- 1. Connect (J1, J2) to 50 Ω instruments. Terminate all unused ports (if applicable) with 50 Ω .
- 2. Connect the supply ground to pin 19 or 20 of J3.
- 3. Connect 3.0 V to VCC, VCC1, and VCC2 of J3.
- 4. Connect 1.8 V to Pin 8 of J3.
- Monitor the 2.5 GHz amplifier transmit performance by applying an RF signal to J2 and monitoring the output power on J1 (ANT).
- 6. Monitor the 2.5 GHz amplifier receive performance by applying an RF signal to connector J1 (ANT) and monitoring the output signal on connector J2.

CAUTION: Care should be taken not to overdrive the amplifier by applying too much RF on the input to the device. A suitable starting input power would be -20 dBm.

Package Dimensions

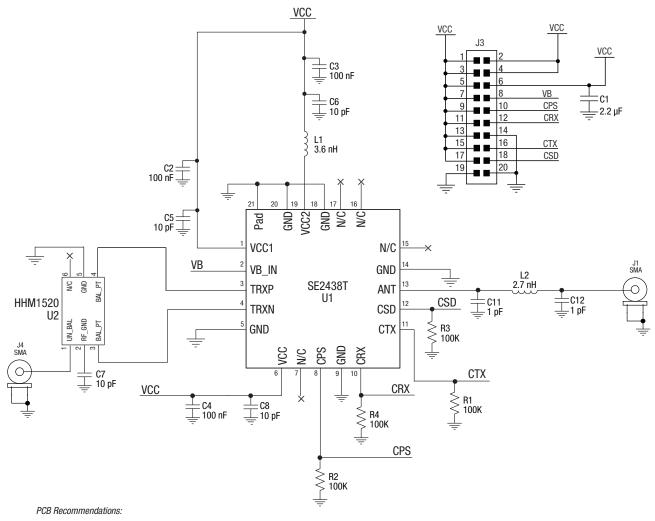
The PCB layout footprint for the SE2438T is provided in Figure 6. Typical case markings for the SE2438T are shown in Figure 7. Package dimensions are shown in Figure 8, and tape and reel dimensions are provided in Figure 9.

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SE2438T package is Pb free, RoHS compliant, halogen free, and rated to Moisture Sensitivity Level 1 (MSL1). For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*. document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



Metal Layer 1 = RF traces + control lines. Core thickness between top RF layer and ground plane is critical. Metal Layer 2 = Solid ground plane. No traces routing.

Metal Layer 3 and 4 = Control lines + VCC traces (no VCC plane).

Pore copper on each layer connected to the ground plane. Use VCC traces in a star distribution pattern.

Always use 4 layers.

Figure 3. SE2438T Evaluation Board Schematic

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Table 9. SE2438T Power and Analog I/O Header: J3, 10x2

Pin Number	Evaluation Board Label	Description	Recommended setting		
14, 19, 20	GND	Ground	General purpose grounds		
1, 3, 5, 6, 7, 9, 11, 13, 15, 17	VCC	Supply voltage	General purpose VCC provided as the main power supply		
4	VCC1	Supply voltage	General purpose VCC provided as the main power supply		
2	VCC2	Supply voltage	General purpose VCC provided as the main power supply		
8	VB	Bias	Output bias to transceiver		
16	CTX	Control			
10	CPS	Control	See Table 8		
18	CSD	Control	See Table 6		
12	CRX	Control			

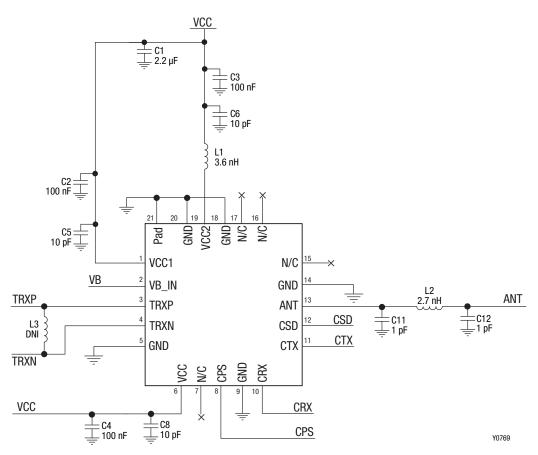
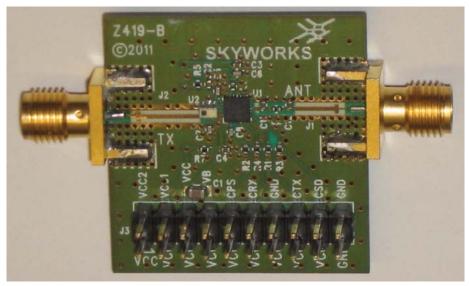


Figure 4. SE2438T Evaluation Board Reference Design Schematic

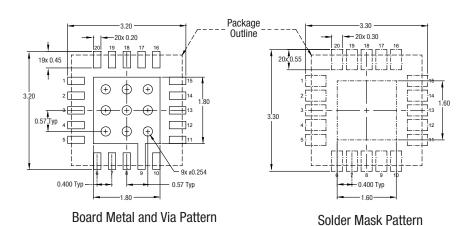
Table 10. SE2438T Evaluation Board Bill of Materials

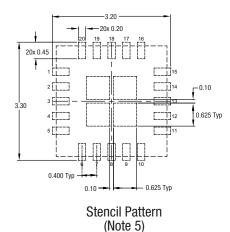
Description	Value	Manufacturer	Mfr Part Number	Package	Description
C1	2.2 μF	Murata	GRM21BR71A225KA01L	0805	Capacitor ceramic 2.2 µF 10 V 10% X7R 0805
L2	2.7 nH	Murata	LQG15HN2N7S02D	0402	High frequency multilayer
L1	3.6 nH	Murata	LQG15HN3N6S02D	0402	High frequency multilayer
J3	10 x 2	Samtec	TSW-110-07-G-D	100MIL	100 mil header
U2	HHM1520	TDK	HHM1520	2.00MMX1.25	Multilayer chip baluns 2.4 GHz
U1	SE2438T	Skyworks	SE2438T	QFN3X3-20	2.4 GHz 14 dBm FEIC
C11, C12	1 pF	Murata	GRM1555C1H1R0CZ01	0402	Multilayer ceramic
J1, J2	SMA	Johnson Components	142-0701-851	End Launch	SMA end launch straight jack receptacle—tab contact
C2, C3, C4	100 nF	Murata	GRM155R71C104KA88D	0402	Monolithic ceramic
C5, C6, C7, C8	10 pF	Murata	GRM1555C1H100JZ01	0402	Multilayer ceramic
R1, R2, R3, R4	100 K	Panasonic	ERJ2GEJ104	0402	Thick film chip resistor



Y0771

Figure 5. SE2438T Evaluation Board Photograph





61% solder coverage on center pad

Notes:

- All dimensions are in millimeters.

(Note 4)

- Dimensions and tolerances according to ASME Y14.5M-1994.
 Unless specified, dimensions are symmetrical about center lines.
 Via hole recommendations: 30 to 35 µm Cu via wall plating (minimum),
- via holes should be tented with solder mask on the back side and filled with solder. Stencil recommendations: 0.125 mm stencil thickness, laser cut
- apertures, trapezoidal walls and rounded corners offer better paste release.
- Solder mask recommendations: contact board fabricator for recommended solder mask offset and tolerance.

Figure 6. PCB Layout Footprint

(Note 6)

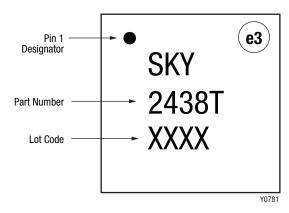
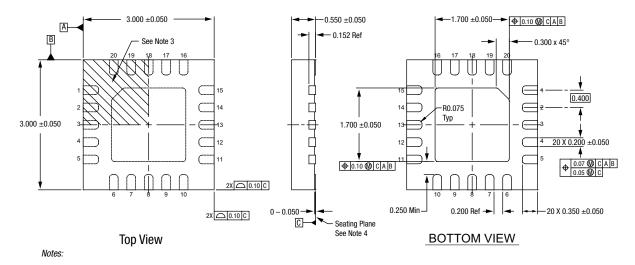


Figure 7. SE2438T Part Marking (Top View)

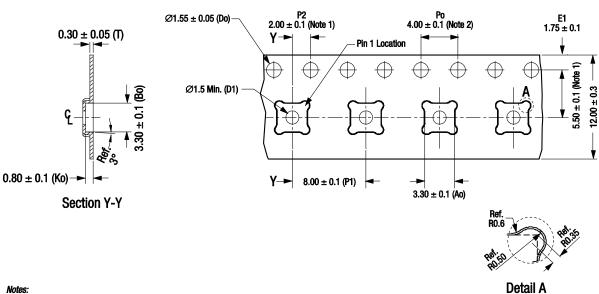
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- 1. All dimensions are in millimeters.
- 2. Dimensions and tolerances according to ASME Y14.5--1994.
- 3. Terminal 1 identification mark located within this area.
- 4. Unilateral coplanarity zone applies to the exposed heat sink ground pad as well as the terminals.

Y0773

Figure 8. SE2438T Package Dimensions



Notes:

St.
Measured from center line of sprocket hole to center line of pocket.
Cumulative toelrance of 10 sprocket holes is ± 0.20 mm.
Other material available.
Typical ESD surface resistivity is from 10⁵ to 10¹¹ Ohms/square per EIA, JEDEC tape and reel specification.

All measurements are in millimeters. S2615

Figure 9. SE2438T-R Tape and Reel Information

Ordering Information

Model Name	Manufacturing Part Number	Evaluation Board Part Number
SE2438T: 2.4 GHz Smart Energy/ZigBee Front-End Module	SE2438T	SE2438T-EK1

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